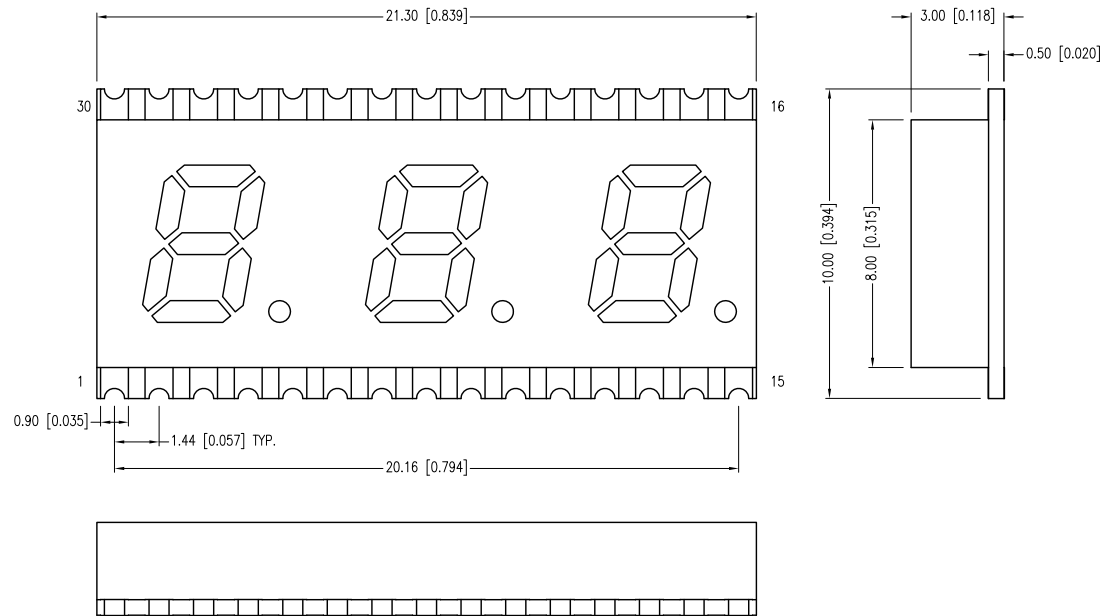


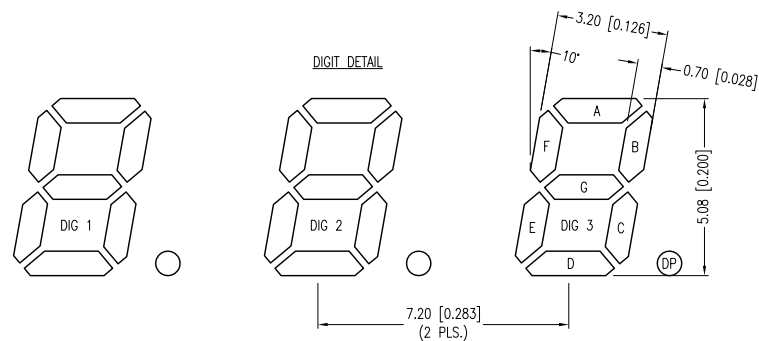
PART NUMBER	LDT-SMC2004RI-SI	REV.	A
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ELECTRO-OPTICAL CHARACTERISTICS $T_a=25^\circ\text{C}$ $I_f=10\text{mA}$

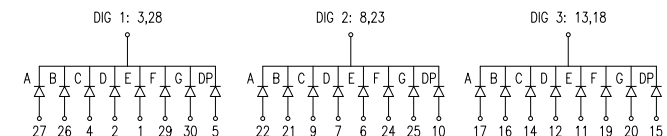
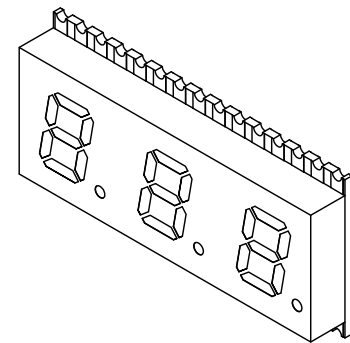
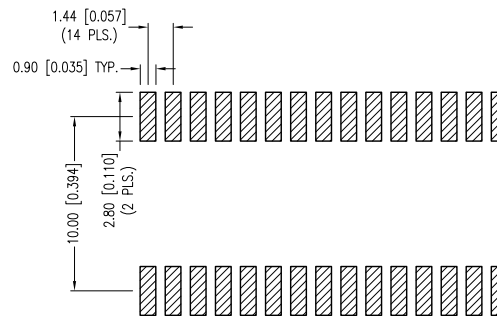
PARAMETER	MIN	TYP	MAX	UNITS	TEST COND
PEAK WAVELENGTH		636		nm	
FORWARD VOLTAGE		2.0	2.5	V _f	
REVERSE VOLTAGE	5.0			V _r	I _r =100 μ A
AXIAL INTENSITY		13,000		μcd	I _f =10mA
EMITTED COLOR:	RED				
FACE COLOR:	GRAY				
LENS FINISH:	MILKY WHITE DIFFUSED				

LIMITS OF SAFE OPERATION AT 25°C PER CHIP

PARAMETER	MAX	UNITS
PEAK FORWARD CURRENT*	150	mA
STEADY CURRENT	30	mA
POWER DISSIPATION	105	mW
DERATE FROM 25°C	-1.2	mW/°C
OPERATING TEMP.	-40 TO +85	°C
STORAGE TEMP.	-40 TO +85	°C

* t<10 μ S

RECOMMENDED SOLDER PAD LAYOUT



*UNLESS OTHERWISE SPECIFIED TOLERANCES PER DECIMAL PRECISION ARE: X=±1 (±0.039), X.X=±0.5 (±0.020), X.XX=±0.25 (±0.010), X.XXX=±0.127 (±0.005). LEAD SIZE=±0.05 (±0.002), LEAD LENGTH=±0.75 (±0.030). MIN.= +DECIMAL PRECISION MAX.= +0.00 -DECIMAL PRECISION

UNCONTROLLED DOCUMENT

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